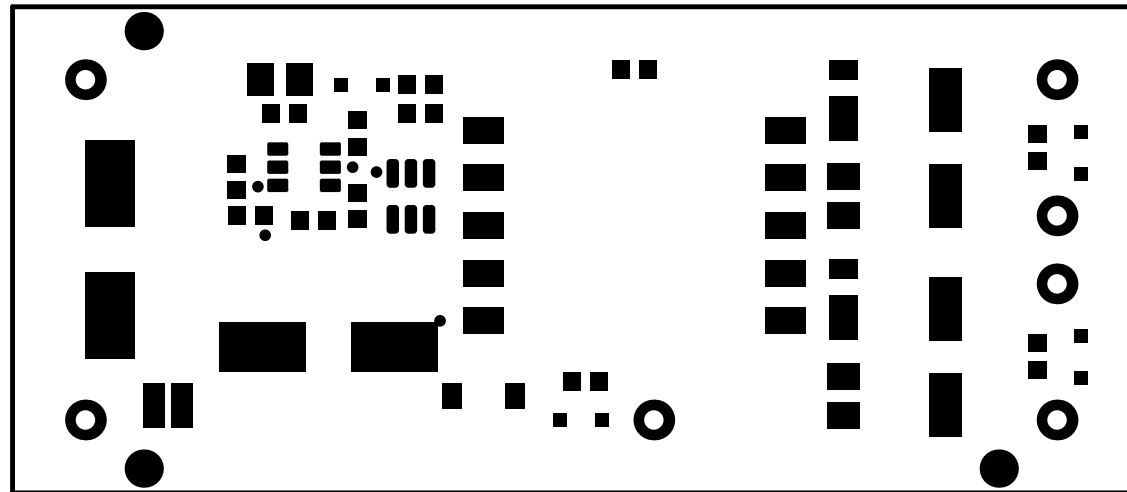
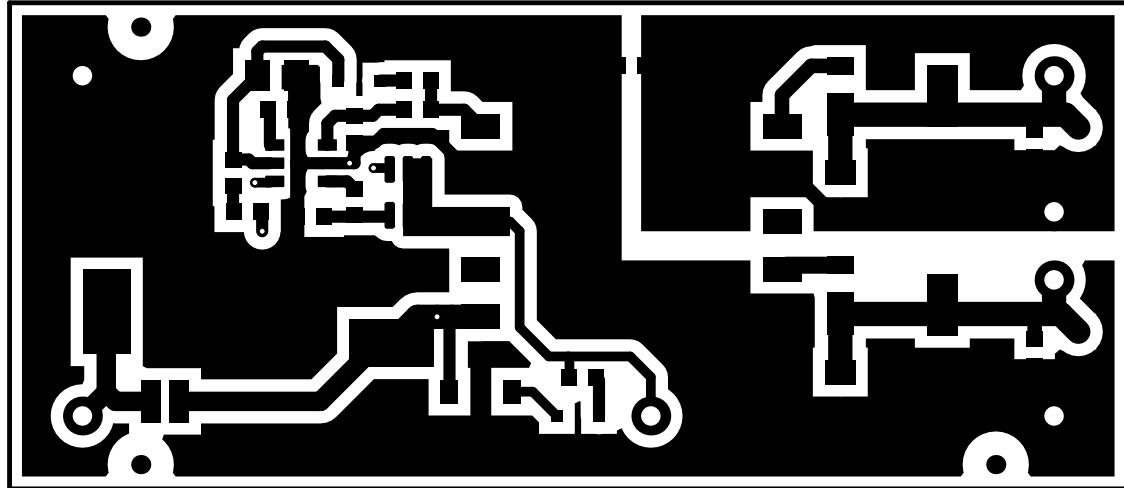


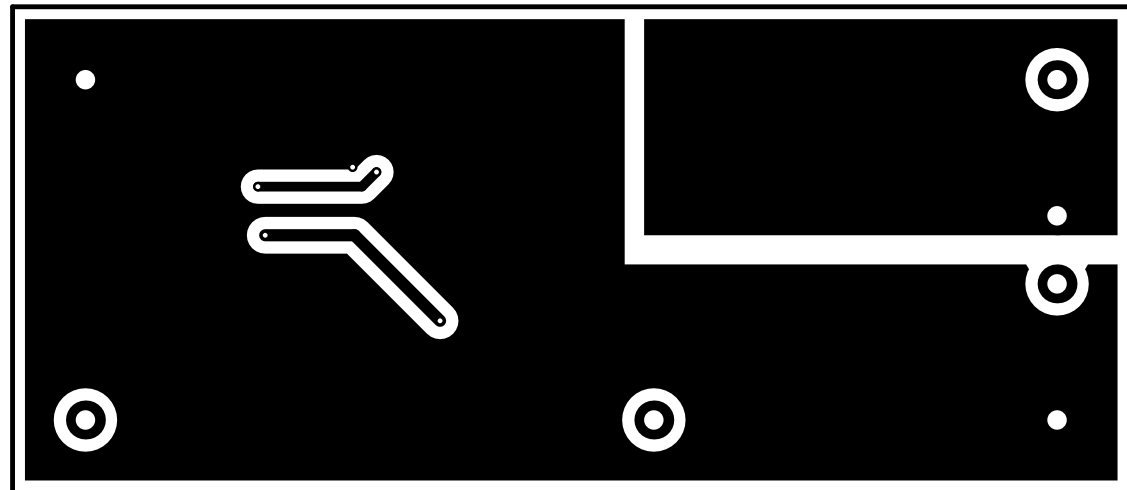
| | | | |
|----------------------------------|------------------------------------|--------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP20583 | REV: A | SUN REV: Not In VersionControl |
| LAYER NAME = Top Overlay | TID #: PMP20583 | | |
| PLOT NAME = Top Overlay | GENERATED : 11/28/2016 12:33:38 PM | | TEXAS INSTRUMENTS |



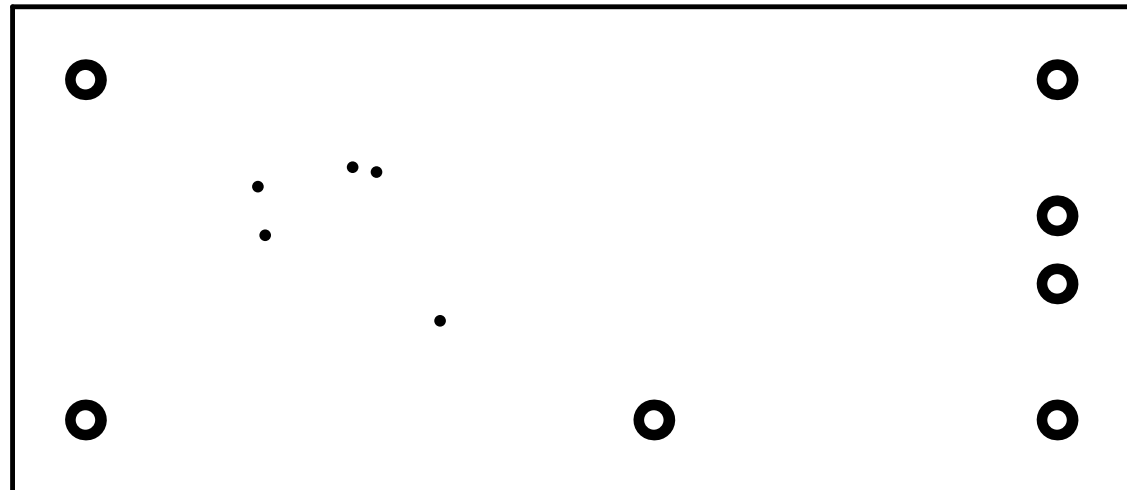
| | | | |
|----------------------------------|------------------------------------|--------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP20583 | REV: A | SVN REV: Not In VersionControl |
| LAYER NAME = Top Solder | TID #: PMP20583 | | |
| PLOT NAME = Top Solder Mask | GENERATED : 11/28/2016 12:33:39 PM | | TEXAS INSTRUMENTS |



| | | | |
|----------------------------------|------------------------------------|--------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP20583 | REV: A | SUN REV: Not In VersionControl |
| LAYER NAME = Top Layer | TID #: PMP20583 | | |
| PLOT NAME = Top Layer | GENERATED : 11/28/2016 12:33:40 PM | | TEXAS INSTRUMENTS |



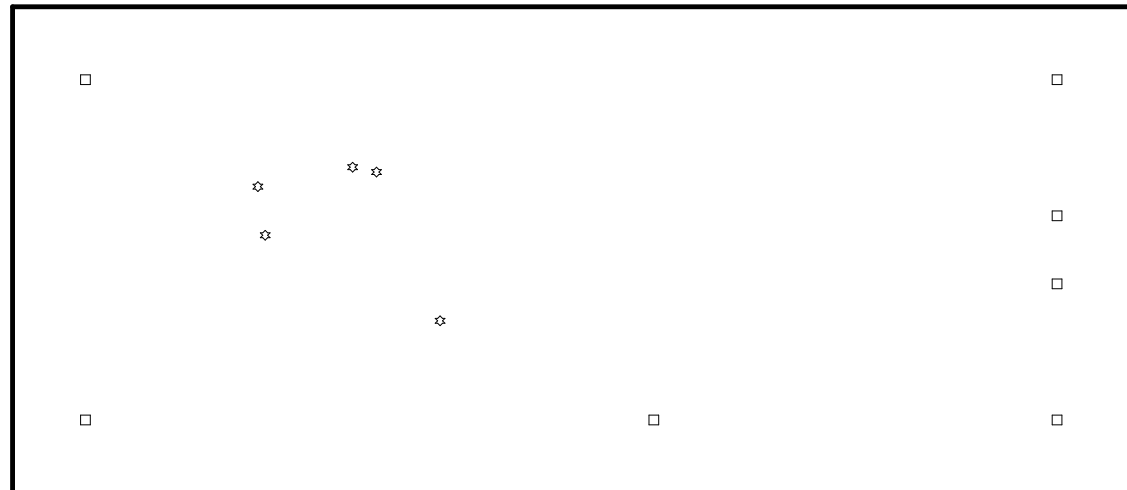
| | | | |
|----------------------------------|------------------------------------|--------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP20583 | REV: A | SVN REV: Not In VersionControl |
| LAYER NAME = Bottom Layer | TID #: PMP20583 | | |
| PLOT NAME = Bottom Layer | GENERATED : 11/28/2016 12:33:41 PM | | TEXAS INSTRUMENTS |



| | | | |
|----------------------------------|------------------------------------|--------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP20583 | REV: A | SVN REV: Not In VersionControl |
| LAYER NAME = Bottom Solder | TID #: PMP20583 | | |
| PLOT NAME = Bottom Solder Mask | GENERATED : 11/28/2016 12:33:42 PM | | TEXAS INSTRUMENTS |

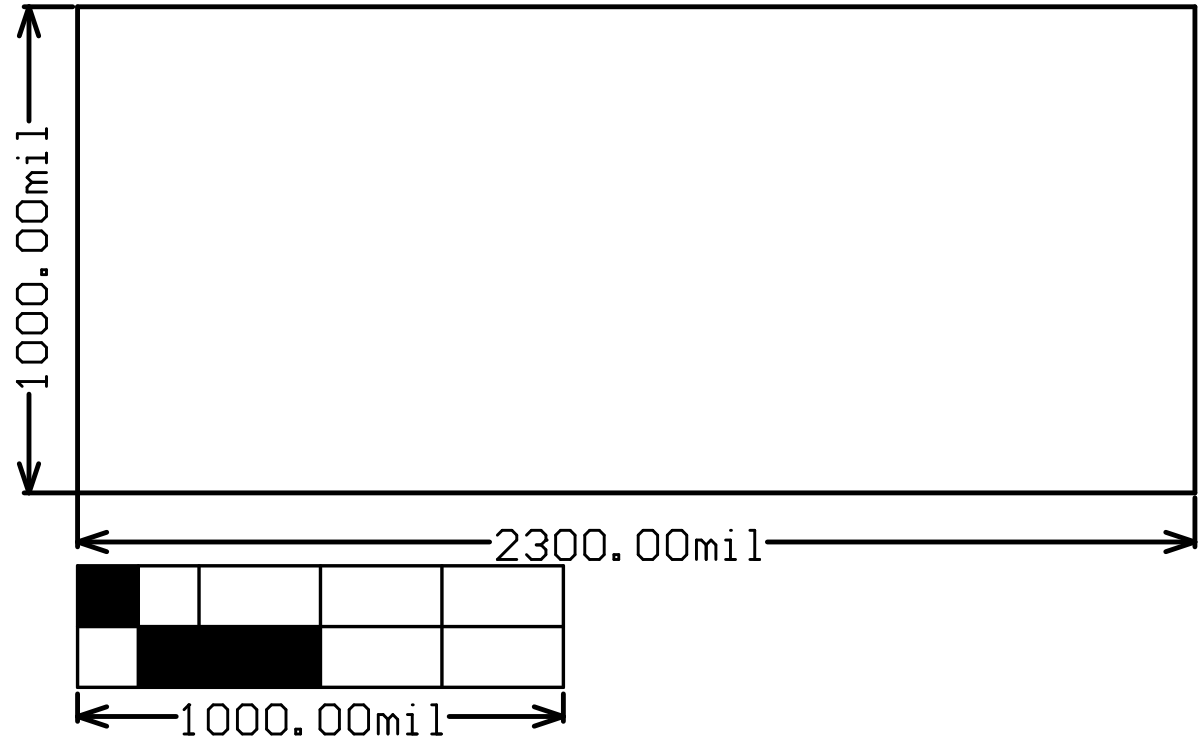


| | | | |
|----------------------------------|------------------------------------|--------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP20583 | REV: A | SUN REV: Not In VersionControl |
| LAYER NAME = Bottom Overlay | TID #: PMP20583 | | |
| PLOT NAME = Bottom Overlay | GENERATED : 11/28/2016 12:33:43 PM | | TEXAS INSTRUMENTS |



| Symbol | Quantity | Finished Hole Size | Plated | Hole Type | Drill Layer Pair | Hole Tolerance |
|--------|----------|--------------------|--------|-----------|--------------------------|----------------|
| ⊛ | 5 | 10.00mil (0.254mm) | PTH | Round | Top Layer - Bottom Layer | |
| □ | 7 | 40.00mil (1.016mm) | PTH | Round | Top Layer - Bottom Layer | |
| | 12 Total | | | | | |

| | | | |
|----------------------------------|------------------------------------|--------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP20583 | REV: A | SUN REV: Not In VersionControl |
| LAYER NAME = Drill Drawing | TID #: PMP20583 | | |
| PLOT NAME = Drill Drawing | GENERATED : 11/28/2016 12:33:44 PM | | TEXAS INSTRUMENTS |



| | | | |
|----------------------------------|------------------------------------|--------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP20583 | REV: A | SUN REV: Not In VersionControl |
| LAYER NAME = M2 Board Dimensions | TID #: PMP20583 | | |
| PLOT NAME = Board Dimensions | GENERATED : 11/28/2016 12:33:45 PM | | TEXAS INSTRUMENTS |

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